

MEMS Engineer Forum 2023

SMART Society Driven by MEMS

April 19-20, 2023

KFC Hall, Ryogoku, Tokyo, Japan

Free charge for conference and exhibition

SPONSORSHIP Guidance

<http://www.m-e-f.info/>

MEF 2023 will be held
In-person format



Speakers for MEF2023

Alphabetical order by last name

Ichiro Amimori, Xenoma Inc. (Japan)
Sonia Costantini, STMicroelectronics (Italy)
Weileun Fang, National Tsing Hua University (Taiwan)
Alissa M. Fitzgerald, A.M. Fitzgerald & Associates, LLC. (USA)
Peter Hartwell, TDK-InvenSense (USA)
Susumu Kaminaga, SPP Technologies Co., Ltd./SK Global Advisers Co., Ltd. (Japan)
Thomas Kenny, Stanford University (USA)
Takashi Kitahara, TESEC Corporation (Japan)
Jerome Mouly, Yole Developpement (France)
Thomas Otto, Fraunhofer ENAS (Germany)
Kurt Petersen, Silicon Valley Band of Angels (USA)
Philippe Robert, CEA-Leti (France)
Florian Schuster, Robert Bosch GmbH (Hungary)
Tetsuya Tanaka, Ricoh (Japan)
Kiyoshi Toko, Kyushu University (Japan)
Gerald Yin, AMEC (China)
Koichi Yoshida, Kanazawa Murata Manufacturing Co., Ltd. (Japan)

and more speakers to be announced.

Sponsors Type and Benefit (10% tax to be added)	GOLD	SILVER	BRONZE
	¥300,000	¥200,000	¥100,000
1 Advertisement for digital MEF Program Handout	A4 full size○	A4 full size○	A4 full size○
2 Logo on MEF Website	○	○	○
3 Logo on MEF Sign board	○	○	○
4 1-min PR Movie Run at breaktime (main hall)	○	○	○
8 Invitation ticket(s) to Networking event (Apr. 19)	2*	1*	×
9 Sp1-min PR Movie Run just before one keynote speech	○	×	×
10 Lunch ticket(s) (Apr.19&20)	3*	2*	1*
11 Meeting room usage	○	○	○
12 Registration List (limited only accepted)	○	○	×

MEF International Advisory Committee

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Vice Chair
Masayoshi Esashi/Tohoku University
Susumu Kaminaga/SPP Technologies/SK Global Advisers
Naoto Kobayashi/Waseda University
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Jean-Christophe Eloy/Yole Developpement
WeiLeun Fang/National Tsing Hua University
Udo-Martin Gomez/Robert Bosch
Thomas Kenny/Stanford University
Xinxin Li/Shanghai Institute of Microsystem and Information Technology
Hiroshi Miyajima/Sumitomo Precision Products
Yutakata Nonomura/Meijo University
Kurt Petersen/Silicon Valley Band of Angels

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Akihiro Koga/Canon Medical Systems Corporation
Osamu Koyanagi/Nippon Investment Company
Masahiro Mita/Kyodo International Inc.
Mitsugu Ogiura/Murata Manufacturing Co., Ltd.
Yoshiaki Oku/ROHM Co., Ltd.
Kazuaki Sawada/Toyohashi University of Technology
Tomonori Seki/OMRON Corporation
Takehisa Takoshima/Tohoku University
Toshiyuki Tsuchiya/Kyoto University
Yoko Yamanishi/Kyushu University
Takashi Yoshida/Yokogawa Electric Corporation

EXHIBIT Booth

All sponsors can enjoy discount exhibit price at additional 200,000 yen for regular booth. (50,000 yen discount).

Regular Booth Spec ¥250,000 (10% tax to be added)
Booth size: W1800mm × D900mm × H2100mm
(Height of table: 700mm)

The following items are included in the booth.

- Back panel
- Affiliation Name Board (standardized design)
- Electric outlet 500W (2 outlets)
- Chair

Academic Booth ¥50,000 (10% tax to be added)
Start-up Booth ¥50,000 (10% tax to be added)

The size of academic and start-up will be smaller.

MEF 2023 Secretariat
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